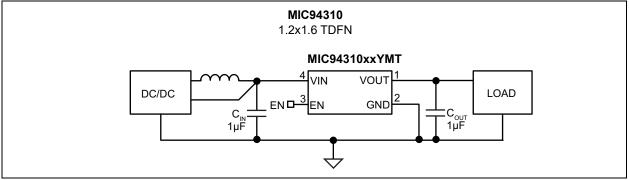
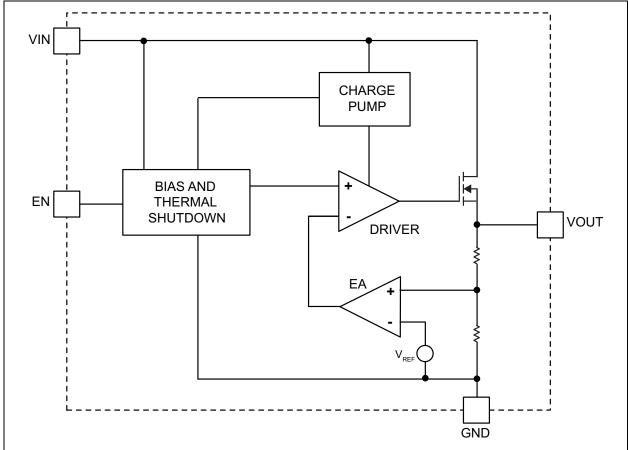
### **Typical Application Circuit**



### Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Input Voltage, V <sub>IN</sub>	
Output Voltage, V <sub>OUT</sub>	
Enable Voltage, V <sub>EN</sub>	
ESD Rating (Note 1)	

## Operating Ratings ++

Supply Voltage, V <sub>IN</sub> +1.8	√ to +3.6V
Enable Voltage, V <sub>EN</sub>	.0V to V <sub>IN</sub>

**† Notice:**Exceeding the "Absolute Maximum Ratings †" may damage the device.

**†† Notice**: The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD-sensitive. Handling precautions are recommended. Human body model, 1.5 kΩ in series with 100 pF.

## **ELECTRICAL CHARACTERISTICS (Note 1)**

**Electrical Characteristics:** Unless otherwise indicated,  $V_{IN} = V_{EN} = V_{OUT} + 500 \text{ mV}$  ( $V_{IN} = V_{EN} = 3.6\text{V}$  for  $V_{OUT} \ge 3.1\text{V}$ );  $I_{OUT} = 1 \text{ mA}$ ;  $C_{OUT} = 1 \mu\text{F}$  (YMT),  $C_{OUT} = 10 \mu\text{F}$  (YM5);  $T_A = 25^{\circ}\text{C}$ , **bold** values indicate  $-40^{\circ}\text{C} \le T_J \le +125^{\circ}\text{C}$ .

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions		
Input Voltage	V <sub>IN</sub>	1.8	_	3.6	V	—		
Output Voltage Accuracy	V <sub>OUT</sub>	-3	±1	+3	%	Variation from nominal V <sub>OUT</sub>		
Drangut Voltage	V <sub>DO</sub>	_	20	50	mV	V <sub>IN</sub> to V <sub>OUT</sub> dropout at 100 mA output current		
Dropout Voltage			40	100	mV	V <sub>IN</sub> to V <sub>OUT</sub> dropout at 200 mA output current		
Load Regulation	ΔV <sub>OUT</sub>		4		mV	I <sub>OUT</sub> = 1 mA to 100 mA		
Line Regulation	$\Delta V_{OUT} / \Delta V_{IN}$		0.01	0.5	%	$V_{IN} = V_{OUT} + 500 \text{ mV} \text{ to } 3.6 \text{V}$		
Ground Current	I <sub>GND</sub>		170	250	μA	No load to full load		
Shutdown Current	I <sub>SHDN</sub>		0.2	5	μA	V <sub>EN</sub> = 0V		
	PSRR		85		dB	f = 100 Hz, I <sub>OUT</sub> = 100 mA		
		_	68	_	dB	f = 100 kHz, I <sub>OUT</sub> = 100 mA		
V <sub>IN</sub> Ripple Rejection			57		dB	f = 1 MHz, I <sub>OUT</sub> = 100 mA		
			50		dB	f = 10 MHz, I <sub>OUT</sub> = 100 mA		
Current Limit	I <sub>LIM</sub>	250	400	700	mA	V <sub>OUT</sub> = 0V		
Total Output Noise	e <sub>no</sub>		83		$\mu V_{RMS}$	f = 10 Hz to 100 kHz		
Turn-on Time	t <sub>ON</sub>		70		μs	—		
Enable								
Input Logic Low Level	V <sub>EN_LOW</sub>		_	0.4	V	_		
Input Logic High Level	V <sub>EN_HIGH</sub>	1.0	_		V	_		
Enable Input Current	I <sub>EN</sub>	_	0.01	1	μA	_		

Note 1: Specification for packaged product only.

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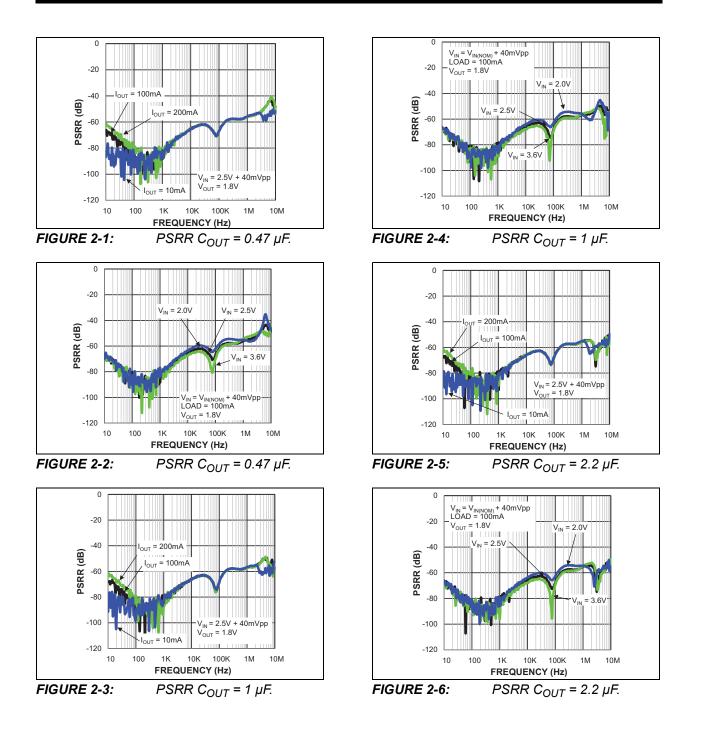
### **TEMPERATURE SPECIFICATIONS**

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Junction Operating Temperature	TJ	-40	_	+125	°C	—	
Lead Temperature	—	—	—	+260	°C	Soldering, 10 sec.	
Storage Temperature Range	Τ <sub>S</sub>	-65	—	+150	°C	—	
Package Thermal Resistances							
Thermal Resistance, TDFN	$\theta_{JA}$	—	173	—	°C/W	—	
Thermal Resistance, SOT-23-5Ld	$\theta_{JA}$	—	120	—	°C/W	—	
Thermal Resistance WLCSP	$\theta_{JA}$		250	—	°C/W	—	

**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

### 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



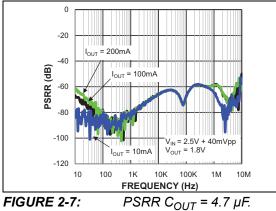
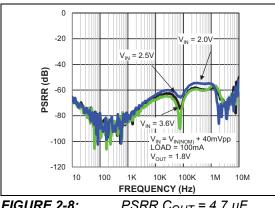
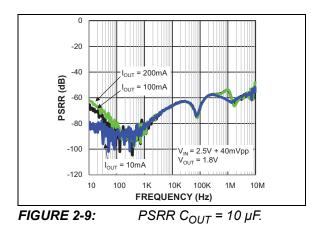


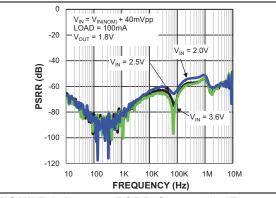
FIGURE 2-7:





PSRR  $C_{OUT}$  = 4.7  $\mu$ F.







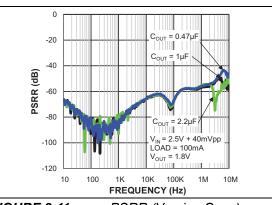
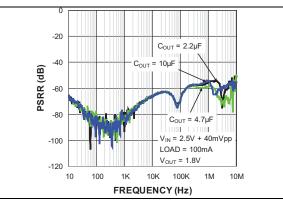


FIGURE 2-11:

PSRR (Varying C<sub>OUT</sub>).



**FIGURE 2-12:** PSRR (Varying C<sub>OUT</sub>).

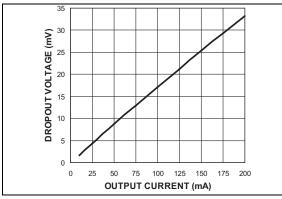


FIGURE 2-13: Drop Voltage vs. Output Current.

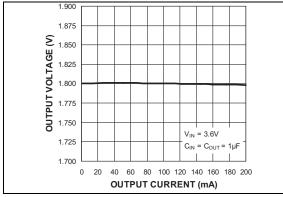


FIGURE 2-14: Current.

Output Voltage vs. Output

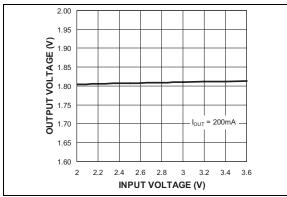
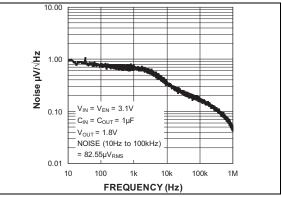


FIGURE 2-15: Output Voltage vs. Input Voltage.



*FIGURE 2-16:* Output Noise Spectral Density.

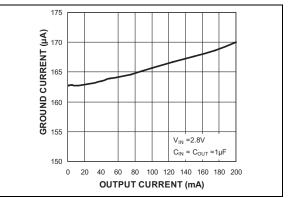


FIGURE 2-17: Ground Current vs. Output Current.

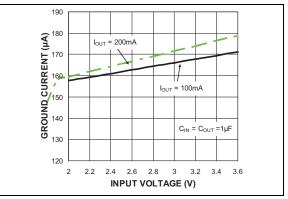


FIGURE 2-18: Ground Current vs. Input Voltage.

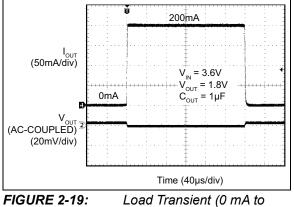


FIGURE 2-19: Load Transient (0 mA 200 mA).

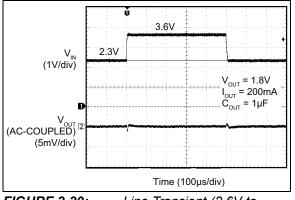


FIGURE 2-20: Line Transient (2.6V to 3.6V).

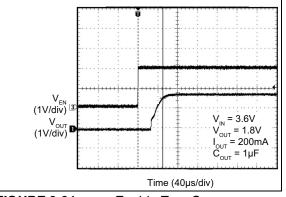
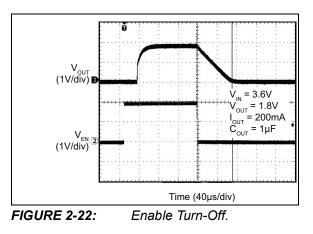


FIGURE 2-21: Enable Turn-On.



### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TADLE J-T.			<b>-</b>					
MIC94310 TDFN	MIC94310 SOT-23	MIC94310 WLCSP	Symbol	Description				
1	5	A2	V <sub>OUT</sub>	Power Switch Output				
2	2	B2	GND	Ground				
3	3	B1	EN	Enable Input A logic HIGH signal on this pin enables the part. Logic LOW disables the part. Do not leave floating.				
4	1	A1	V <sub>IN</sub>	Power switch input and chip supply				
—	4	—	NC	No Connect, not internally connected				
EP	_		EPAD	Exposed Heatsink Pad Connect to ground for best thermal performance.				

#### TABLE 3-1: PIN FUNCTION TABLE

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### 4.0 APPLICATION INFORMATION

The MIC94310 is a very-high PSRR, fixed-output, 200 mA LDO utilizing Ripple Blocker technology. The MIC94310 is fully protected from damage due to fault conditions, offering linear current limiting and thermal shutdown.

#### 4.1 Input Capacitor

The MIC94310 is a high-performance, high-bandwidth device. An input capacitor of 0.47  $\mu$ F is required from the input to ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit. X5R or X7R dielectrics are recommended for the input capacitor. Y5V dielectrics lose most of their capacitance over temperature and are therefore, not recommended.

#### 4.2 Output Capacitance

In order to maintain stability, the MIC94310 requires an output capacitor of 0.47 µF or greater for the Thin DFN package and 10 µF or greater for the SOT-23 package. For optimal ripple rejection performance, a 1 µF capacitor is recommended for the Thin DFN package. A 10 µF capacitor is recommended for the SOT-23 package. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors are not recommended because they may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a 1 µF ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric type ceramic capacitors are recommended because of their temperature performance. X7R type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change their value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with the Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

### 4.3 No Load Stability

The MIC94310 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

#### 4.4 Enable/Shutdown

Forcing the enable (EN) pin low disables the MIC94310 and sends it into a "zero" off mode current state. In this state, current consumed by the MIC94310 goes nearly to zero. Forcing EN high enables the output voltage. The EN pin uses CMOS technology and cannot be left floating as it could cause an indeterminate state on the output.

#### 4.5 Thermal Considerations

The MIC94310 is designed to provide 200 mA of continuous current in a very small package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. For example if the input voltage is 2.5V, the output voltage is 1.8V, and the output current equals 200 mA. The actual power dissipation of the Ripple Blocker can be determined using Equation 4-1:

#### **EQUATION 4-1:**

$$P_D = (V_{IN} - V_{OUT1})I_{OUT} + V_{IN}I_{GND}$$

Because this device is CMOS and the ground current is typically <170  $\mu$ A over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for the calculation shown in Equation 4-2 and Equation 4-3.

**EQUATION 4-2:** 

$$P_D = (2.5V - 1.8V) \times 200 \text{ mA}$$

**EQUATION 4-3:** 

$$P_D = 0.14W$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the Equation 4-4:

#### **EQUATION 4-4:**

$$P_{D(MAX)} = \left(\frac{T_{J(MAX)} - T_A}{\theta_{JA}}\right)$$

 $T_{J(MAX)}$  = 125°C, the maximum junction temperature of the die,  $\theta_{JA}$  thermal resistance = 173°C/W for the Thin DFN package.

Substituting  $P_D$  for  $P_{D(MAX)}$  and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit.

For proper operation, the maximum power dissipation must not be exceeded.

For example, when operating the MIC94310-GYMT at an input voltage of 2.5V and 200 mA load with a minimum footprint layout, the maximum ambient operating temperature ( $T_A$ ) can be determined as follows:

#### **EQUATION 4-5:**

```
0.14W = (125^{\circ}C - T_A)/(173^{\circ}C/W)
```

#### **EQUATION 4-6:**

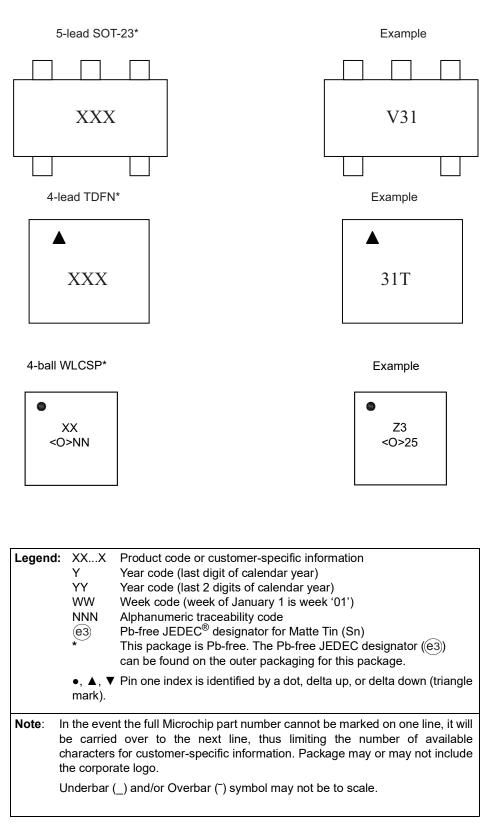
 $T_A = 101^{\circ}C$ 

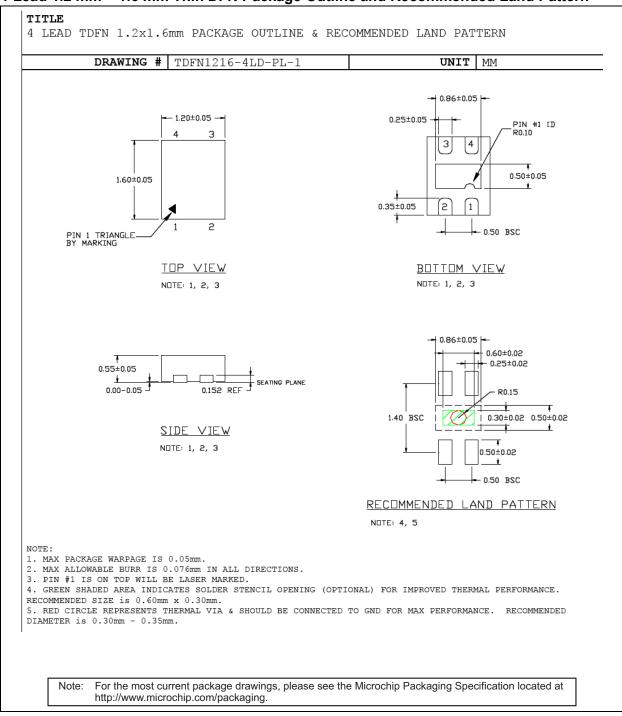
Therefore, the maximum ambient operating temperature allowed in a 1.2 mm  $\times$  1.6 mm Thin DFN package is 101°C.

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### 5.0 PACKAGING INFORMATION

#### 5.1 Package Marking Information

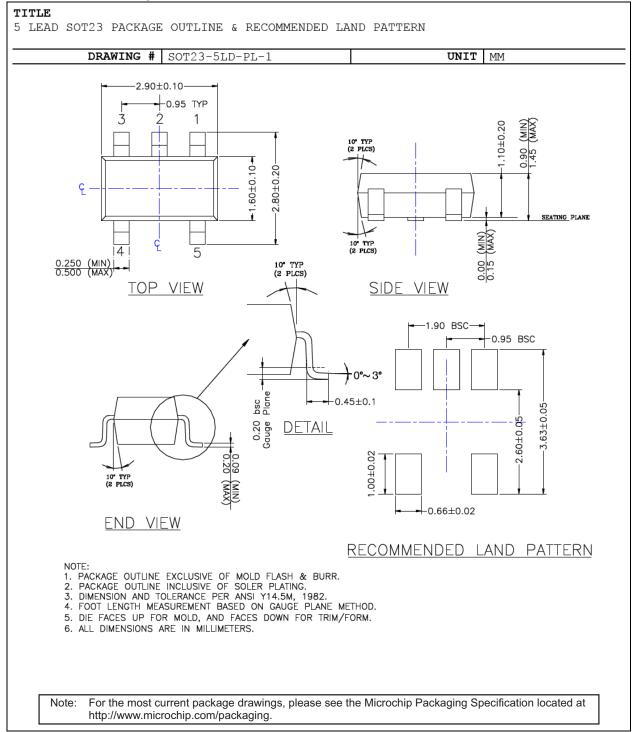


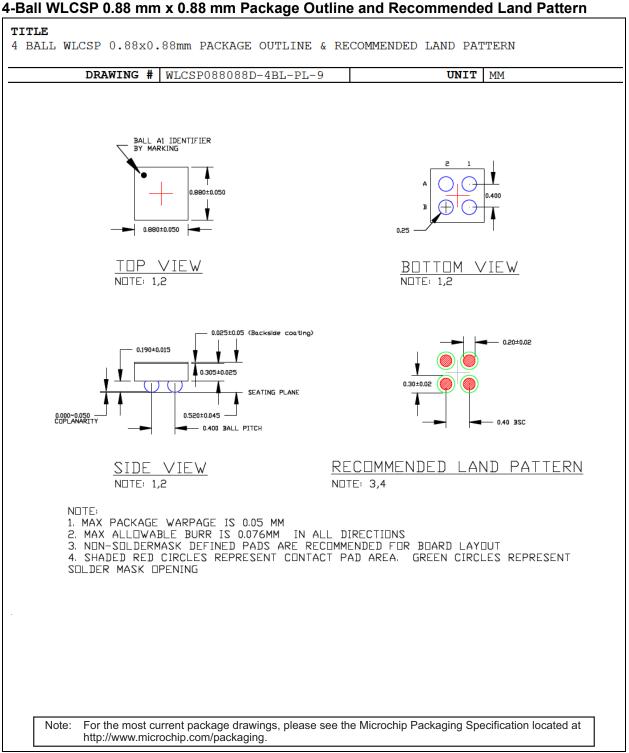


### 4-Lead 1.2 mm × 1.6 mm Thin DFN Package Outline and Recommended Land Pattern

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#### 5-Pin SOT-23 Package Outline and Recommended Land Pattern





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NOTES:

### APPENDIX A: REVISION HISTORY

#### **Revision B (September 2020)**

• Added 0.88 mm × 0.88 mm 4-Ball WLCSP package.

### **Revision A (October 2018)**

- Converted Micrel document MIC94310 to Microchip data sheet template DS20006105A.
- Minor grammatical text changes throughout.

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NOTES:

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PART NO.	- <u>X</u>	<u>×</u>	<u>XX</u>	- <u>XX</u>	EXC	amples:	
Device	T Output Voltage	t Temperature	Package	Media Type	a)	MIC94310-4YMT-T5:	200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, –40°C to +85°C Temperature Range, 5-Lead TDFN, 5,000/ Reel
Device:	MIC94310:	200 mA LDO with Ri	pple Blocker <sup>™</sup>	Technology	b)	MIC94310-4YMT-TR:	200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature
Output Voltage:	F = G = D = J =	1.2V 1.5V 1.8V 1.85V 2.5V 2.7V			c)	MIC94310-4YM5-T5:	Range, 5-Lead TDFN, 5,000/ Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature Range, 5-Lead SOT-235,000/
	N = P =	2.8V 2.85V 3.0V 3.3V			d)	MIC94310-4YM5-TR:	Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, –40°C to +85°C Temperature Range, 5-Lead
Temperature Range:	Y = E =	-40°C to +85°C -40°C to +125°C			e)	MIC94310-4YMT-T5:	SOT-23, 5,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature
Packages:	M5 =	4-Lead 1.2 mm × 1.6 r 5-Lead SOT-23 4-Ball 0.88 mm × 0.88			f)	MIC94310-4YMT-TR:	Range, 5-Lead TDFN, 5,000/ Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +88°C Temperature
Media Type:	TR = TR =	3,000/Reel (SOT-23) 5,000/Reel (TDFN) 3,000/Reel (WLCSP) 500/Reel			g)	MIC94310-4YM5-T5:	Range, 5-Lead TDFN, 5,000/ Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature Range, 5-Lead SOT-23 5,000/
					h)	MIC94310-4YM5-TR:	Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature
					i)	MIC94310-4YCS-TR:	Range, 5-Lead SOT-23, 5,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2 Output Voltage -40°C to +125°C
					j)	MIC94310-GYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 1.8 Output Voltage -40°C to +125°C
					k)	MIC94310-JYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 2.5 Output Voltage -40°C to +125°C
					I)	MIC94310-MYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 2.8 Output Voltage -40°C to +125°C
					m)	MIC94310-PYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 0.0 Output Voltage -40°C to +125°C
catalog pa identifier i is not prin	art number des s used for orde ted on the dev	only appears in the scription. This ering purposes and vice package. Check es Office for package			n)	MIC94310-SYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 3.3 Output Voltage -40°C to +125°C Extended Temperature Range,

NOTES:

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